



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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GL610T

Chip Type Infrared Emitting Diode

■ Features

1. Subminiature (Dimensions : 1.6 × 1.6 × 0.8mm)
2. Thin type (Thickness : 0.8mm)
3. Taped model (4 000pcs./reel)
4. Leadless type

■ Applications

1. Small and thin type remote control units
2. Tape end detectors for VCR, VCR camera
3. Light source of tatch panel for car navigation system
4. Portable equipment

■ Absolute Maximum Ratings (Ta=25°C)

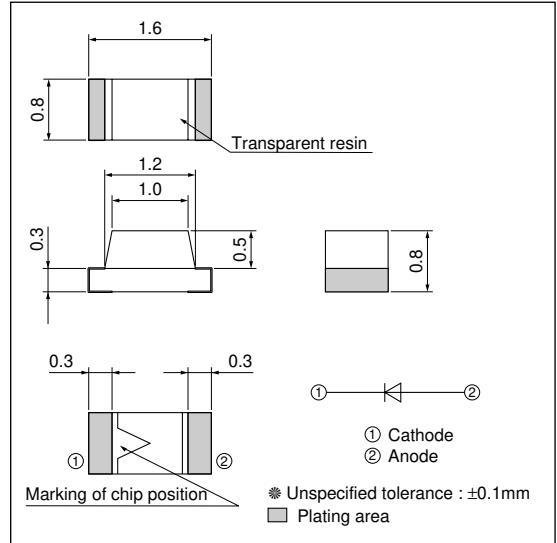
Parameter	Symbol	Rating	Unit
Forward current	I _F	50	mA
*1 Peak forward current	I _{FM}	500	mA
Reverse voltage	V _R	6	V
Power dissipation	P	150	mW
Operating temperature	T _{opr}	-25 to +85	°C
Storage temperature	T _{stg}	-25 to +100	°C
*2 Soldering temperature	T _{sol}	260	°C

*1 Pulse width=100μs, Duty ratio=0.01

*2 Hand soldering temperature, for MAX. 3s

■ Outline Dimensions

(Unit : mm)



■ Electro-optical Characteristics

(Ta=25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V_F	$I_F=50\text{mA}$	–	1.3	1.5	V
*1 Peak forward voltage	V_{FM}	$I_{FM}=0.5\text{A}$	–	2.2	3.5	V
Reverse current	I_R	$V_R=3\text{V}$	–	–	10	μA
Radiant flux	ϕ_e	$I_F=20\text{mA}$	0.7	2.0	–	mW
Peak emission wavelength	λ_p	$I_F=20\text{mA}$	–	950	–	nm
Spectrum radiation bandwidth	$\Delta\lambda$	$I_F=20\text{mA}$	–	40	–	nm
Response frequency	fc	–	–	300	–	kHz
Half intensity angle	$\Delta\theta$	$I_F=20\text{mA}$	–	± 60	–	°

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